

UT2327

Power MOSFET

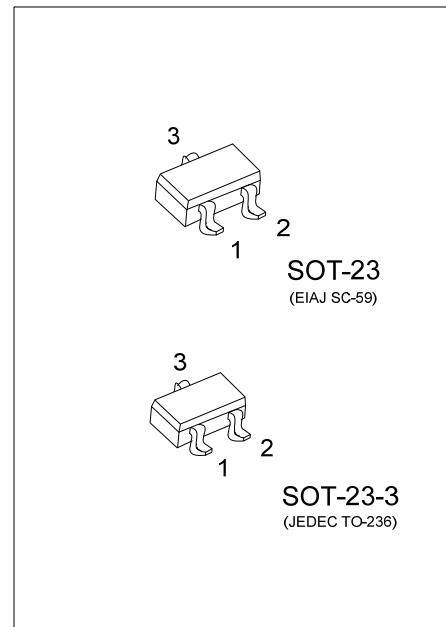
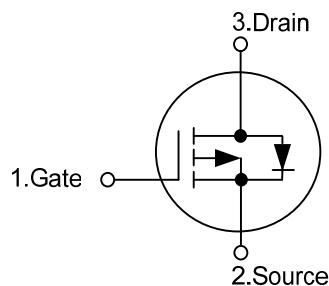
P-CHANNEL ENHANCEMENT MODE

■ DESCRIPTION

The UTC **UT2327** is P-channel enhancement mode Power MOSFET, designed in serried ranks. with fast switching speed, low on-resistance, favorable stabilization.

Used in commercial and industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

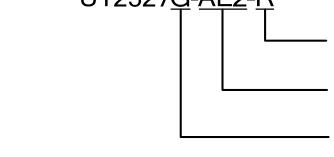
■ SYMBOL



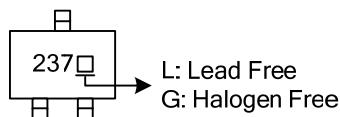
■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UT2327L-AE2-R	UT2327G-AE2-R	SOT-23-3	G	S	D	Tape Reel
UT2327L-AE3-R	UT2327G-AE3-R	SOT-23	G	S	D	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

 (1)Packing Type (2)Package Type (3)Green Package	(1) R: Tape Reel (2) AE2: SOT-23-3, AE3: SOT-23 (3) G: Halogen Free and Lead Free, L: Lead Free
---	---

■ MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_A=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATING	UNIT
Drain-Source Voltage	V_{DS}	- 20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current (Note 3)	I_D	-2.6	A
		-2.1	A
Pulsed Drain Current (Note 1, 2)	I_{DM}	-10	A
Total Power Dissipation ($T_A=25^\circ\text{C}$)	P_D	1.38	W
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL	RATING	UNIT
Junction to Ambient (Note 3)	θ_{JA}	90	$^\circ\text{C}/\text{W}$

■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

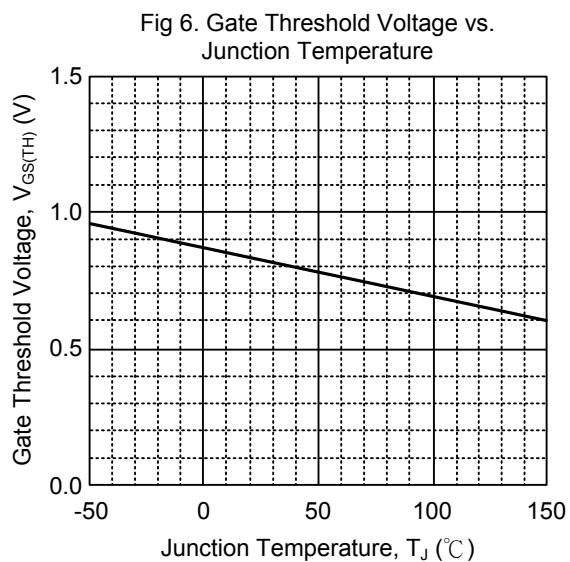
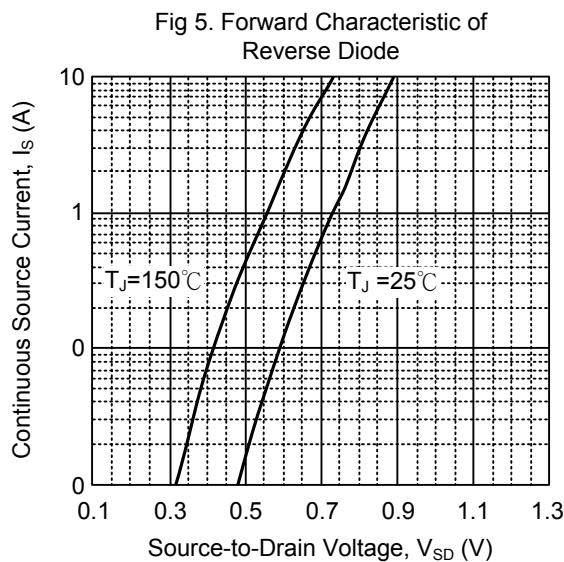
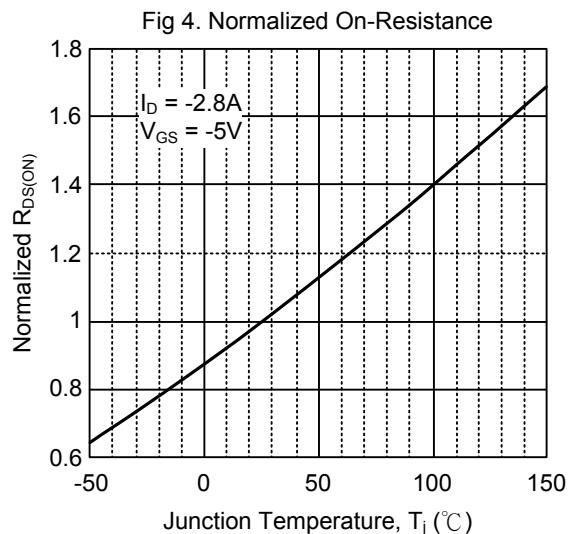
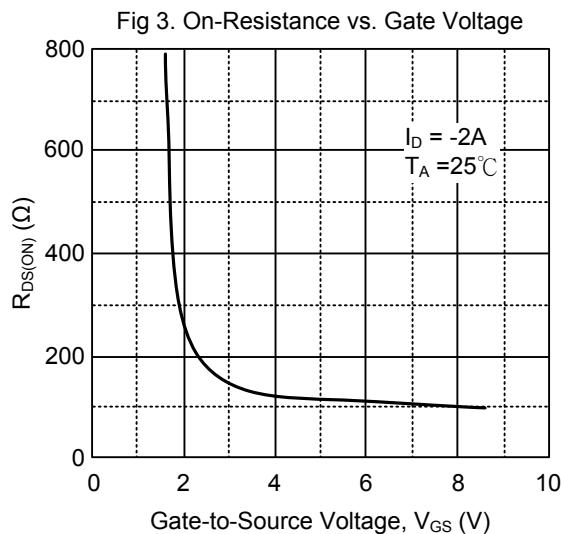
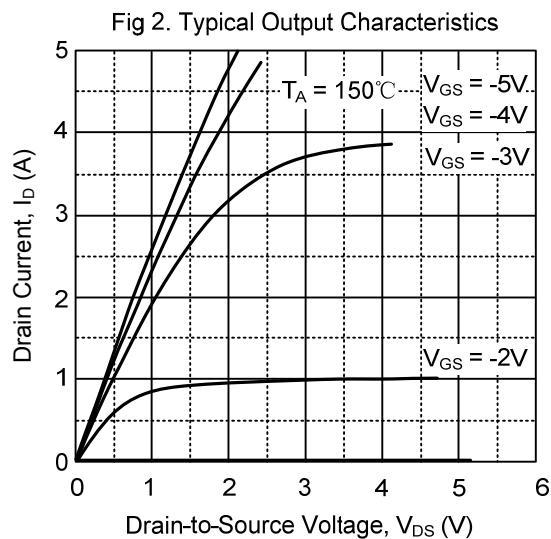
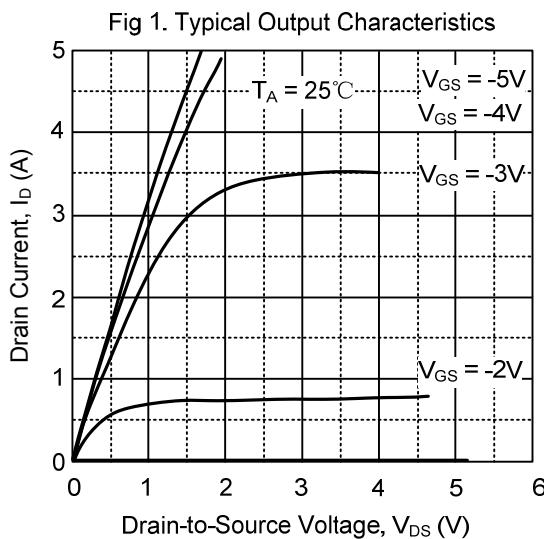
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0\text{V}, I_D=-250\mu\text{A}$	-20			V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-20\text{V}, V_{GS}=0\text{V}$			-1	μA
		$V_{DS}=-16\text{V}, V_{GS}=0\text{V}$			-10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12\text{V}$			± 100	nA
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=-1\text{mA}$		-0.1		$\text{V}/^\circ\text{C}$
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}, I_D=-250\mu\text{A}$	-0.5			V
Drain-Source On-State Resistance (Note 2)	$R_{DS(\text{ON})}$	$V_{GS}=-5\text{V}, I_D=-2.8\text{A}$			130	$\text{m}\Omega$
		$V_{GS}=-2.8\text{V}, I_D=-2.0\text{A}$			190	$\text{m}\Omega$
Forward Transconductance	g_{FS}	$V_{DS}=-5\text{V}, I_D=-2.8\text{A}$		4.4		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C_{ISS}	$V_{GS}=0\text{V}, V_{DS}=-6\text{V}, f=1.0\text{MHz}$			295	pF
Output Capacitance	C_{OSS}				170	pF
Reverse Transfer Capacitance	C_{RSS}				65	pF
SWITCHING CHARACTERISTICS						
Total Gate Charge (Note 2)	Q_G	$V_{DS}=-6\text{V}, V_{GS}=-5\text{V}, I_D=-2.8\text{A}$			5.2	nC
Gate-Source Charge	Q_{GS}				1.36	nC
Gate-Drain Charge	Q_{GD}				0.6	nC
Turn-ON Delay Time (Note 2)	$t_{D(\text{ON})}$	$V_{DS}=-15\text{V}, V_{GS}=-10\text{V}, I_D=-1\text{A}, R_G=6\Omega, R_D=15\Omega$			5.2	ns
Turn-ON Rise Time	t_R				9.7	ns
Turn-OFF Delay Time	$t_{D(\text{OFF})}$				19	ns
Turn-OFF Fall Time	t_F				29	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Maximum Continuous Drain-Source Diode Forward Current	I_S	$V_D=V_G=0\text{V}, V_S=-1.2\text{V}$			-1	A
Maximum Pulsed Drain-Source Diode Forward Current (Note 1)	I_{SM}				-10	A
Drain-Source Diode Forward Voltage (Note 2)	V_{SD}	$T_J=25^\circ\text{C}, I_S=-1.6\text{A}, V_{GS}=0\text{V}$			-1.2	V

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$.

3. Surface mounted on 1 in² copper pad of FR4 board; $270^\circ\text{C} / \text{W}$ when mounted on min.

■ TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)

Fig 7. Gate Charge Characteristics

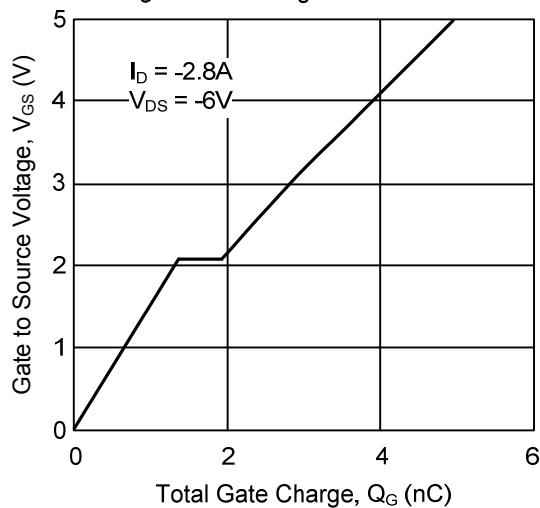


Fig 8. Typical Capacitance Characteristics

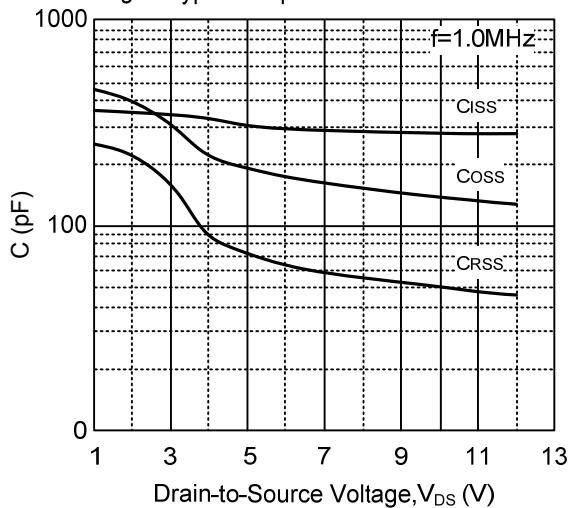


Fig 9. Maximum Safe Operating Area

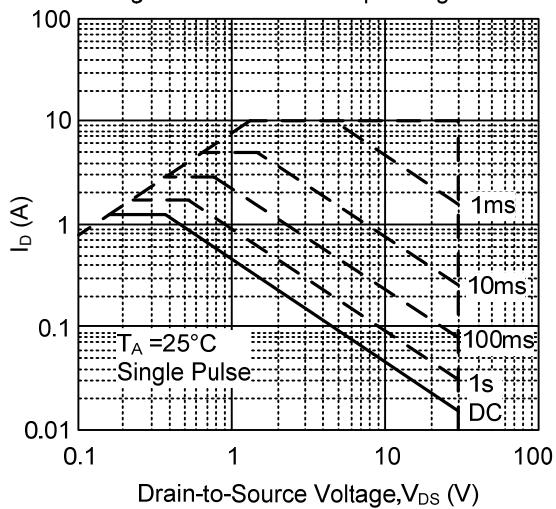


Fig 10. Effective Transient Thermal Impedance

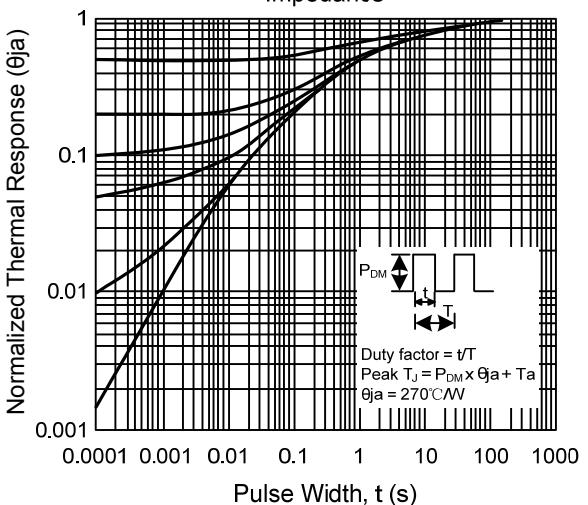


Fig 11. Switching Time Waveform

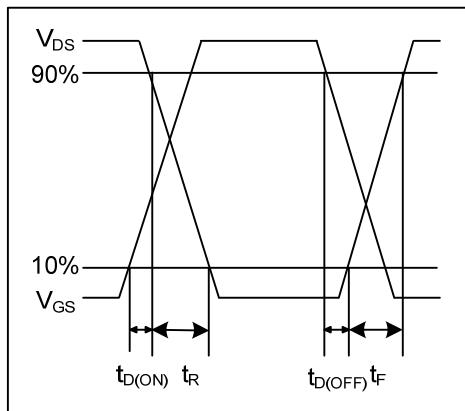
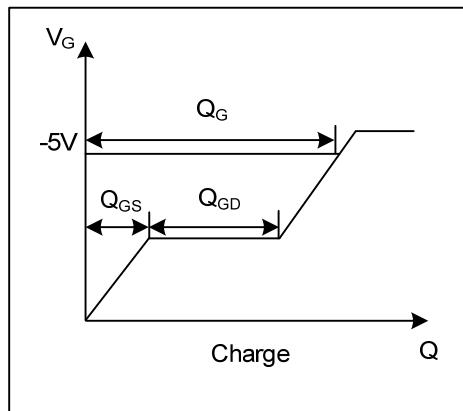


Fig 12. Gate Charge Waveform



UTC assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all UTC products described or contained herein. UTC products are not designed for use in life support appliances, devices or systems where malfunction of these products can be reasonably expected to result in personal injury. Reproduction in whole or in part is prohibited without the prior written consent of the copyright owner. UTC reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

